

APPLICATION INFORMATION

Demoboard W-CDMA for the BGA2003

Application Note

Demoboard W-CDMA for the BGA2003**Application Note**

1 SUMMARY**• Description of products**

Monolithic Microwave Integrated Circuit (MMIC): RF transistor with internal bias circuit. The benefit is lower component count, low production spread and enabling function by I_{ctrl} with high isolation when shutoff.

• Application Area

Low noise amplifier for systems like GSM, DECT, DCS with low component count.

• Presented Application

The application presents a low noise amplifier for W-CDMA at 3400 MHz with matching components.

• Main results

An amplifier has been designed and tested for application in W-CDMA with minimum component count:

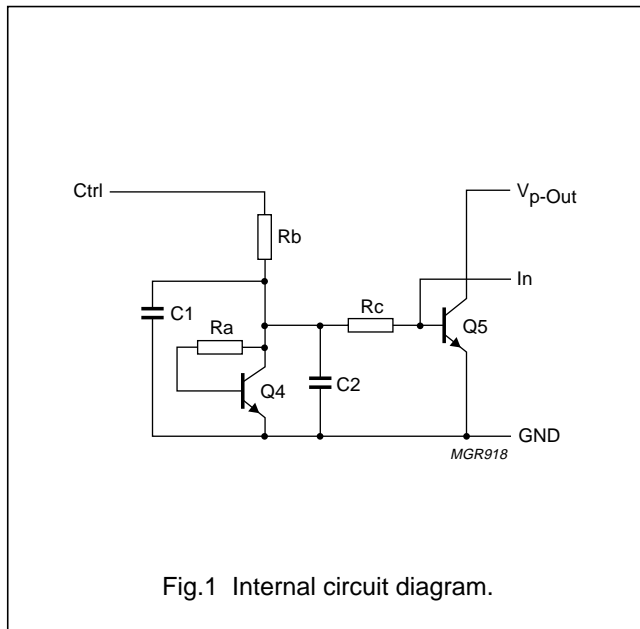
- Frequency is 3400 MHz; $I_{supply} = 4.7$ mA;
Gain = 9.4 dB; IIP3 = 2.1 dBm; Noise Figure (NF) = 2.7 dB;
 $VSWR_{in} = 1.4$; $VSWR_{out} = 1.6$
- Frequency is 3400 MHz; $I_{supply} = 10$ mA;
Gain = 10.3 dB; IIP3 = 9.2 dBm; Noise Figure = 3.1 dB;
 $VSWR_{in} = 1.2$; $VSWR_{out} = 1.6$.

Demoboard W-CDMA for the BGA2003

Application Note

2 THE INTERNAL BGA2003 CIRCUIT

For understanding of the behaviour of the BGA2003 MMIC circuit the internal circuit diagram is given in Fig.1.



Q5 is the main RF transistor. Q4 forms a current mirror with Q5. The input current of this current mirror is determined by the current into pin Ctrl. Rb limits the current when a control voltage is applied directly to the Ctrl input. Rc, C1, and C2 decouple the bias circuit from the RF input signal.

3 SIMULATION OF THE BGA2003 DEMOBOARD

S-parameters of the BGA2003 MMIC were measured at $V_{p-Out} = 2.5\text{ V}$, $I_{supply} = 4\text{ mA}$ up to 3 GHz. HP-MDS simulation was used to extrapolate to 3.4 GHz and optimize component values for gain, noise and matching. These component values have been used as a starting point for finding the used practical component values (see Table 1).

Demoboard W-CDMA for the BGA2003

Application Note

4 APPLICATION CIRCUIT

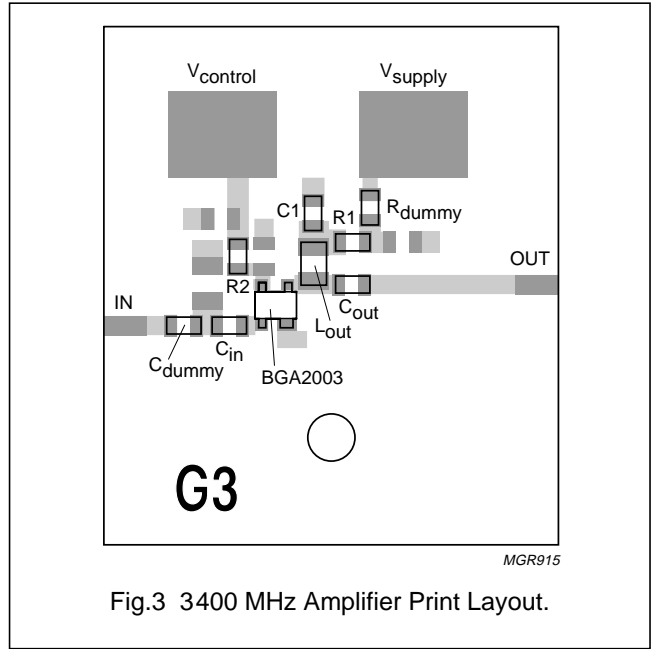
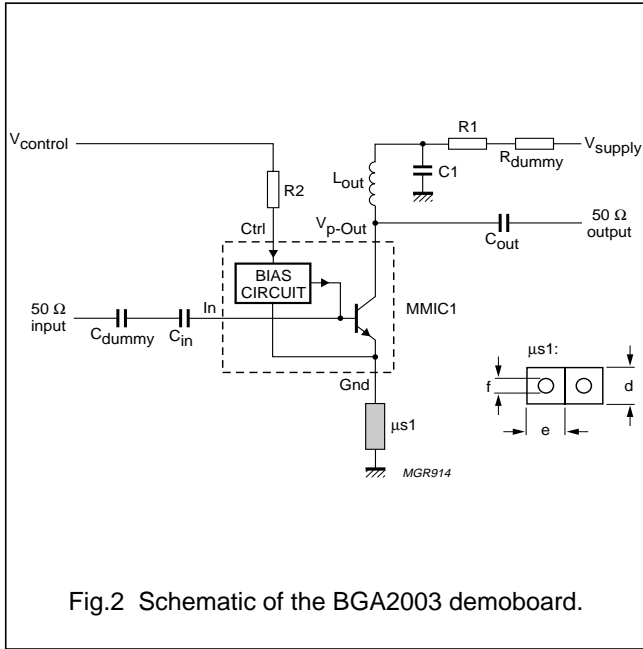


Table 1 Used components for the BGA2003 demoboard

COMPONENT	VALUE	UNIT	SIZE - MANUFACTURER	PURPOSE; COMMENT
C _{dummy}	150	pF	0603 Philips	connecting dummy (NP0); see Chapter 5
C _{in}	47	pF	0603 Philips	DC-decoupling; input match
C _{out}	0.82	pF	0603 Philips	output match
L _{out}	2.2	nH	0603 AVX type 1200	output match
C1	2.2	pF	0603 Philips	RF-short to ground
R _{dummy}	0	Ω	0603 Philips	connecting dummy, short; see Chapter 5
R1	120	Ω	0603 Philips	DC-bias; RF decoupling
R2	4.7	kΩ	0603 Philips	DC-bias; bias setting
μs1	–	–	PCB via	d = e = 1 mm; f = 0.4 mm
MMIC1	BGA2003	–	Philips SOT343R1	
PCB	–	–	FR4	ε _R ~ 4.6; H = 0.5 mm

Demoboard W-CDMA for the BGA2003

Application Note

Table 2 Measured values

$V_{\text{supply}} = 3.0 \text{ V}$; $V_{\text{control}} = 3.0 \text{ V}$; $I_{\text{supply}} = 4.66 \text{ mA}$; $f = 3400 \text{ MHz}$; see note 1.

S-PARAMETERS	CONDITION	TYP.	UNIT	VSWR
S ₁₁		-16.4	dB	1.4
S ₂₁		+9.4	dB	–
S ₁₂		-15.2	dB	–
S ₂₂		-13.1	dB	1.6
NF		+2.65	dB	–
Input IP3	at -30 dBm in; note 2	+2.1	dBm	–

Notes

1. S-parameters measured at -30 dBm input level.
2. IP3 -30 dBm in, f1 and f2 100 kHz separated.

Table 3 Measured values

$V_{\text{supply}} = 3.7 \text{ V}$; $V_{\text{control}} = 6.0 \text{ V}$; $I_{\text{supply}} = 10 \text{ mA}$; $f = 3400 \text{ MHz}$; note 1.

S-PARAMETERS	TYP.	UNIT	VSWR
Spars with $I_{\text{ctrl}} = 0$			
S ₁₁	-3.85	dB	4.6
S ₂₁	-19.1	dB	–
S ₁₂	-19.3	dB	–
S ₂₂	-5.27	dB	3.4

Note

1. Switch off isolation.

5 COMMENTS ON THE PRINTED CIRCUIT BOARD

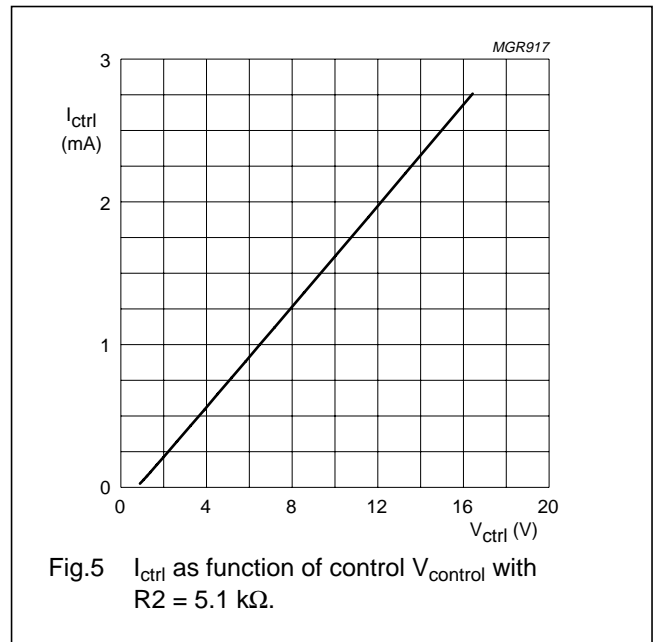
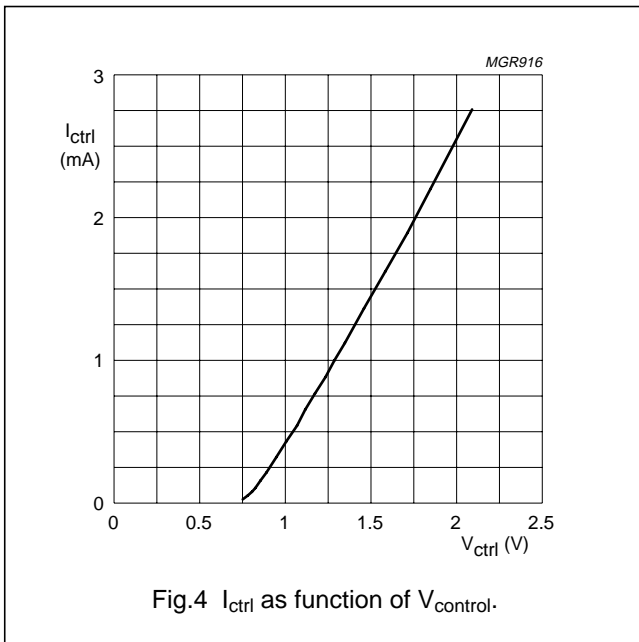
This Printed Circuit Board (PCB) is developed for a LNA with the BGA2003, with component positions for extra decoupling and matching. Although this application was designed for minimal component count, two extra components R_{dummy} and C_{dummy} were needed as interconnect on this PCB. With a new PCB these components can be left out. C_{in} is for DC-decoupling the input to the circuit and matching to 50 Ω . L_{out} and C_{out} match the circuit to the 50 Ω output. Decoupling the supply for high frequencies is done by R1 and C1. The value of R1 determines the voltage on $V_{\text{p-out}}$, which was designed to be 2.5 V with a supply current of 4 mA. The value of R2 and the value of V_{control} determine the control current and thereby the collector current. With 4.7 k Ω for R2 and V_{ctrl} 3.0 V a supply current of 4.66 mA was set (see Figs 4 and 5).

I_{supply} can also be estimated by calculation with formula:
$$I_{\text{supply}} = \frac{10 \times (V_{\text{control}} - 0.83)}{(R2 + 152)}$$

Coil L_{out} can be replaced by a stripline made on the PCB itself. C_{in} can be omitted in some applications when the input signal is not DC coupled.

Demoboard W-CDMA for the BGA2003

Application Note



For higher IIP3 a supply current of 10 mA was set by applying larger V_{ctrl} (6 V). V_{supply} was raised to 3.7 V to compensate for the extra voltage drop across R1 to keep voltage on pin V_{p-Out} to 2.5 V. To get the same supply current of 10 mA at 3 V supply, and keep voltage on pin V_{p-Out} to 2.5 V, R1 should be changed from 120 Ω into 47 Ω .

Table 4 Measured values on the BGA2003 demoboard

$V_{supply} = 3.7\text{ V}$; $V_{control} = 6.06\text{ V}$; $I_{supply} = 10.0\text{ mA}$; 3400 MHz; see note 1

S-PARAMETERS	CONDITION	TYP.	UNIT	VSWR
S_{11}		-20.4	dB	1.2
S_{21}		+10.3	dB	-
S_{12}		-14.8	dB	-
S_{22}		-12.9	dB	1.6
NF		+3.10	dB	-
Input IP3	at -20 dBm in; note 2	+9.2	dBm	-

Notes

1. S-parameters measured at -30 dBm input level.
2. IP3: 2x -20 dBm in; f1 and f2 100 kHz separated.

Demoboard W-CDMA for the BGA2003

Application Note

NOTES

Philips Semiconductors – a worldwide company

Argentina: see South America

Australia: 34 Waterloo Road, NORTH RYDE, NSW 2113, Tel. +61 2 9805 4455, Fax. +61 2 9805 4466

Austria: Computerstr. 6, A-1101 WIEN, P.O. Box 213, Tel. +43 1 60 101 1248, Fax. +43 1 60 101 1210

Belarus: Hotel Minsk Business Center, Bld. 3, r. 1211, Volodarski Str. 6, 220050 MINSK, Tel. +375 172 20 0733, Fax. +375 172 20 0773

Belgium: see The Netherlands

Brazil: see South America

Bulgaria: Philips Bulgaria Ltd., Energoproject, 15th floor, 51 James Bourchier Blvd., 1407 SOFIA, Tel. +359 2 68 9211, Fax. +359 2 68 9102

Canada: PHILIPS SEMICONDUCTORS/COMPONENTS, Tel. +1 800 234 7381, Fax. +1 800 943 0087

China/Hong Kong: 501 Hong Kong Industrial Technology Centre, 72 Tat Chee Avenue, Kowloon Tong, HONG KONG, Tel. +852 2319 7888, Fax. +852 2319 7700

Colombia: see South America

Czech Republic: see Austria

Denmark: Sydhavnsgade 23, 1780 COPENHAGEN V, Tel. +45 33 29 3333, Fax. +45 33 29 3905

Finland: Sinikalliontie 3, FIN-02630 ESPOO, Tel. +358 9 615 800, Fax. +358 9 6158 0920

France: 51 Rue Carnot, BP317, 92156 SURESNES Cedex, Tel. +33 1 4099 6161, Fax. +33 1 4099 6427

Germany: Hammerbrookstraße 69, D-20097 HAMBURG, Tel. +49 40 2353 60, Fax. +49 40 2353 6300

Greece: No. 15, 25th March Street, GR 17778 TAVROS/ATHENS, Tel. +30 1 489 4339/4239, Fax. +30 1 481 4240

Hungary: see Austria

India: Philips INDIA Ltd, Band Box Building, 2nd floor, 254-D, Dr. Annie Besant Road, Worli, MUMBAI 400 025, Tel. +91 22 493 8541, Fax. +91 22 493 0966

Indonesia: PT Philips Development Corporation, Semiconductors Division, Gedung Philips, Jl. Buncit Raya Kav.99-100, JAKARTA 12510, Tel. +62 21 794 0040 ext. 2501, Fax. +62 21 794 0080

Ireland: Newstead, Clonskeagh, DUBLIN 14, Tel. +353 1 7640 000, Fax. +353 1 7640 200

Israel: RAPAC Electronics, 7 Kehilat Saloniki St, PO Box 18053, TEL AVIV 61180, Tel. +972 3 645 0444, Fax. +972 3 649 1007

Italy: PHILIPS SEMICONDUCTORS, Piazza IV Novembre 3, 20124 MILANO, Tel. +39 2 6752 2531, Fax. +39 2 6752 2557

Japan: Philips Bldg 13-37, Kohnan 2-chome, Minato-ku, TOKYO 108-8507, Tel. +81 3 3740 5130, Fax. +81 3 3740 5077

Korea: Philips House, 260-199 Itaewon-dong, Yongsan-ku, SEOUL, Tel. +82 2 709 1412, Fax. +82 2 709 1415

Malaysia: No. 76 Jalan Universiti, 46200 PETALING JAYA, SELANGOR, Tel. +60 3 750 5214, Fax. +60 3 757 4880

Mexico: 5900 Gateway East, Suite 200, EL PASO, TEXAS 79905, Tel. +9-5 800 234 7381, Fax +9-5 800 943 0087

Middle East: see Italy

Netherlands: Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB, Tel. +31 40 27 82785, Fax. +31 40 27 88399

New Zealand: 2 Wagener Place, C.P.O. Box 1041, AUCKLAND, Tel. +64 9 849 4160, Fax. +64 9 849 7811

Norway: Box 1, Manglerud 0612, OSLO, Tel. +47 22 74 8000, Fax. +47 22 74 8341

Pakistan: see Singapore

Philippines: Philips Semiconductors Philippines Inc., 106 Valero St. Salcedo Village, P.O. Box 2108 MCC, MAKATI, Metro MANILA, Tel. +63 2 816 6380, Fax. +63 2 817 3474

Poland: Ul. Lukiska 10, PL 04-123 WARSZAWA, Tel. +48 22 612 2831, Fax. +48 22 612 2327

Portugal: see Spain

Romania: see Italy

Russia: Philips Russia, Ul. Usatcheva 35A, 119048 MOSCOW, Tel. +7 095 755 6918, Fax. +7 095 755 6919

Singapore: Lorong 1, Toa Payoh, SINGAPORE 319762, Tel. +65 350 2538, Fax. +65 251 6500

Slovakia: see Austria

Slovenia: see Italy

South Africa: S.A. PHILIPS Pty Ltd., 195-215 Main Road Martindale, 2092 JOHANNESBURG, P.O. Box 7430 Johannesburg 2000, Tel. +27 11 470 5911, Fax. +27 11 470 5494

South America: Al. Vicente Pinzon, 173, 6th floor, 04547-130 SÃO PAULO, SP, Brazil, Tel. +55 11 821 2333, Fax. +55 11 821 2382

Spain: Balmes 22, 08007 BARCELONA, Tel. +34 93 301 6312, Fax. +34 93 301 4107

Sweden: Kottbygatan 7, Akalla, S-16485 STOCKHOLM, Tel. +46 8 5985 2000, Fax. +46 8 5985 2745

Switzerland: Allmendstrasse 140, CH-8027 ZÜRICH, Tel. +41 1 488 2741 Fax. +41 1 488 3263

Taiwan: Philips Semiconductors, 6F, No. 96, Chien Kuo N. Rd., Sec. 1, TAIPEI, Taiwan Tel. +886 2 2134 2886, Fax. +886 2 2134 2874

Thailand: PHILIPS ELECTRONICS (THAILAND) Ltd., 209/2 Sanpavuth-Bangna Road Prakanong, BANGKOK 10260, Tel. +66 2 745 4090, Fax. +66 2 398 0793

Turkey: Talatpasa Cad. No. 5, 80640 GÜLTEPE/ISTANBUL, Tel. +90 212 279 2770, Fax. +90 212 282 6707

Ukraine: PHILIPS UKRAINE, 4 Patrice Lumumba str., Building B, Floor 7, 252042 KIEV, Tel. +380 44 264 2776, Fax. +380 44 268 0461

United Kingdom: Philips Semiconductors Ltd., 276 Bath Road, Hayes, MIDDLESEX UB3 5BX, Tel. +44 181 730 5000, Fax. +44 181 754 8421

United States: 811 East Arques Avenue, SUNNYVALE, CA 94088-3409, Tel. +1 800 234 7381, Fax. +1 800 943 0087

Uruguay: see South America

Vietnam: see Singapore

Yugoslavia: PHILIPS, Trg N. Pasica 5/v, 11000 BEOGRAD, Tel. +381 11 62 5344, Fax. +381 11 63 5777

For all other countries apply to: Philips Semiconductors, International Marketing & Sales Communications, Building BE-p, P.O. Box 218, 5600 MD EINDHOVEN, The Netherlands, Fax. +31 40 27 24825

Internet: <http://www.semiconductors.philips.com>

© Philips Electronics N.V. 1999

SCA62

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

Printed in The Netherlands

125006/3100/01/pp8

Date of release: 1999 Feb 16

Document order number: 9397 nnn nnnnn

Let's make things better.

**Philips
Semiconductors**



PHILIPS

SUNSTAR 商斯达实业集团是集研发、生产、工程、销售、代理经销、技术咨询、信息服务等为一体的高科技企业，是专业高科技电子产品生产厂家，是具有 10 多年历史的专业电子元器件供应商，是中国最早和最大的仓储式连锁规模经营大型综合电子零部件代理分销商之一，是一家专业代理和分销世界各大品牌 IC 芯片和电子元器件的连锁经营综合性国际公司，专业经营进口、国产名厂名牌电子元件，型号、种类齐全。在香港、北京、深圳、上海、西安、成都等全国主要电子市场设有直属分公司和产品展示展销窗口门市部专卖店及代理分销商，已在全国范围内建成强大统一的供货和代理分销网络。我们专业代理经销、开发生产电子元器件、集成电路、传感器、微波光电元器件、工控机/DOC/DOM 电子盘、专用电路、单片机开发、MCU/DSP/ARM/FPGA 软件硬件、二极管、三极管、模块等，是您可靠的一站式现货配套供应商、方案提供商、部件功能模块开发配套商。商斯达实业公司拥有庞大的资料库，有数位毕业于著名高校——有中国电子工业摇篮之称的西安电子科技大学（西军电）并长期从事国防尖端科技研究的高级工程师为您精挑细选、量身订做各种高科技电子元器件，并解决各种技术问题。

微波光电部专业代理经销高频、微波、光纤、光电元器件、组件、部件、模块、整机；电磁兼容元器件、材料、设备；微波 CAD、EDA 软件、开发测试仿真工具；微波、光纤仪器仪表。欢迎国外高科技微波、光纤厂商将优秀产品介绍到中国、共同开拓市场。长期大量现货专业批发高频、微波、卫星、光纤、电视、CATV 器件：晶振、VCO、连接器、PIN 开关、变容二极管、开关二极管、低噪晶体管、功率电阻及电容、放大器、功率管、MMIC、混频器、耦合器、功分器、振荡器、合成器、衰减器、滤波器、隔离器、环行器、移相器、调制解调器；光电子元件和组件：红外发射管、红外接收管、光电开关、光敏管、发光二极管和发光二极管组件、半导体激光二极管和激光器组件、光电探测器和光接收组件、光发射接收模块、光纤激光器和光放大器、光调制器、光开关、DWDM 用光发射和接收器件、用户接入系统光收发器件与模块、光纤连接器、光纤跳线/尾纤、光衰减器、光纤适配器、光隔离器、光耦合器、光环行器、光复用器/转换器；无线收发芯片和模组、蓝牙芯片和模组。

更多产品请看本公司产品专用销售网站：

商斯达中国传感器科技信息网：<http://www.sensor-ic.com/>

商斯达工控安防网：<http://www.pc-ps.net/>

商斯达电子元器件网：<http://www.sunstare.com/>

商斯达微波光电产品网：[HTTP://www.rfoe.net/](http://www.rfoe.net/)

商斯达消费电子产品网：<http://www.icasic.com/>

商斯达实业科技产品网：<http://www.sunstars.cn/> 微波元器件销售热线：

地址：深圳市福田区福华路福庆街鸿图大厦 1602 室

电话：0755-82884100 83397033 83396822 83398585

传真：0755-83376182 (0) 13823648918 MSN: SUNS8888@hotmail.com

邮编：518033 E-mail:szss20@163.com QQ: 195847376

深圳赛格展销部：深圳华强北路赛格电子市场 2583 号 电话：0755-83665529 25059422

技术支持：0755-83394033 13501568376

欢迎索取免费详细资料、设计指南和光盘；产品凡多，未能尽录，欢迎来电查询。

北京分公司：北京海淀区知春路 132 号中发电子大厦 3097 号

TEL: 010-81159046 82615020 13501189838 FAX: 010-62543996

上海分公司：上海市北京东路 668 号上海赛格电子市场 D125 号

TEL: 021-28311762 56703037 13701955389 FAX: 021-56703037

西安分公司：西安高新开发区 20 所(中国电子科技集团导航技术研究所)

西安劳动南路 88 号电子商城二楼 D23 号

TEL: 029-81022619 13072977981 FAX:029-88789382